

FASTSWITCH HOLLOW-EMITTER NPN TRANSISTORS

- HIGH SWITCHING SPEED NPN POWER TRANSISTORS
- HOLLOW EMITTER TECHNOLOGY
- HIGH VOLTAGE FOR OFF-LINE APPLICA-TIONS
- 50kHz SWITCHING SPEED
- LOW COST DRIVE CIRCUITS
- LOW DYNAMIC SATURATION

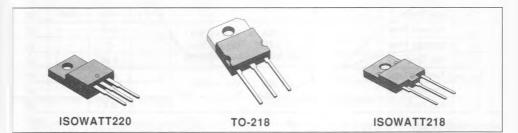
APPLICATIONS

- SMPS
- TV HORIZONTAL DEFLECTION

DESCRIPTION

-ollow emitter FASTSWITCH NPN power transisers are specially designed for 220V (and 117V with put doubler) off-line switching power supply and coour CRT deflection applications. High voltage hollow emitter transistors can operate up to 50kHz with low cost drive circuits. These transistors can be used to advantage in off-line switching power supply applications where their high voltage rating is a benefit because costly transformer clamp windings or over voltage snubbing can be omitted. These transistors are suitable for application in flyback and forward single transistor low power converters, 50W to 100W. When used in conjunction with a Power MOSFET in emitter switch configuration in flyback and forward converters, they can operate at over 100kHz.

These hollow emitter FASTSWITCH transistors are available in TO-218 and fully isolated ISOWATT220 and ISOWATT218 packages. The ISOWATT218 conforms to the creepage distance and isolation requirements of VDE, IEC, and UL specifications.



ABSOLUTE MAXIMUM RATINGS

Symbol	Deservator	SGS			
	Parameter	IF325	F425	IF425	Unit
VCES	Collector - Emitter Voltage (V _{BE} = 0)	1300			V
VCEO	Collector - Emitter Voltage (I ₈ = 0)	600			V
VEBO	Emitter - Base Voltage (I _C = 0)	7			V
I _C	Collector Current	4			A
СМ	Collector Peak Current (tp < 5ms)	8			A
I _B	Base Current	3			A
IBM	Base Peak Current (tp < 5ms)	6			A
Ptot	Total Dissipation at T _c ≤ 25°C	35	80	45	W
Tstg	Storage Temperature - 65 to	150	150	150	°C
T,	Junction Temperature	150	150	150	°C

SGSF325-SGSF425-SGSIF425

THERMAL DATA

			SGS			
			IF325	F425	IF425	
R _{thj-case}	Thermal Resistance Junction-case	Max	3.57	1.56	2.78	°C/W

ELECTRICAL CHARACTERISTICS (T_{case} = 25°C unless otherwise specified)

Symbol	Parameter	Test Conditions		Тур.	Max.	Unit
ICES	Collector Cutoff Current (V _{BE} = 0)	V _{CE} = 1300V			200	μА
ICEO	Collector Cutoff Current (I _B = 0)	V _{CE} = 380V V _{CE} = 600V			200 2	μA mA
IEBO	Emitter Cutoff Current ($I_C = 0$)	V _{EB} = 7V			1	mA
V _{CEO (sus)} .	Collector Emitter Sustaining Voltage	$l_{\rm C} = 0.1 {\rm A}$	600			V
V _{CE (sat)} .	Collector Emitter Saturation Voltage	$I_{C} = 1.25A$ $I_{B} = 0.25A$ $I_{C} = 1A$ $I_{B} = 0.15A$			1.5 1.5	V V
VBE (sat)*	Base Emitter Saturation Voltage	$I_{C} = 1.25A$ $I_{B} = 0.25A$ $I_{C} = 1A$ $I_{B} = 0.15A$			1.5 1.5	V V

RESISTIVE LOAD

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
ton	Turn-on Time			0.6	1	μs
ts	Storage Time	$I_{C} = 1.25A$ $V_{CC} = 250V$ $I_{B1} = 0.25A$ $I_{B2} = -2I_{B1}$		3	4.5	μs
tr	Fall Time	181 - 0.237 182 - 2181		0.2	0.35	μs
ton	Turn-on Time	$I_{\rm C} = 1.25$ A $V_{\rm CC} = 250$ V	,	0.6		μs
ts	Storage Time	$I_{B1} = 0.25A$ $I_{B2} = -2I_{B1}$		2		μs
tr	Fall Time	With Antisaturation Network	<	0.16		μs
ton	Turn-on Time			0.6		μs
ts	Storage Time	$I_{C} = 1.25A$ $V_{CC} = 250V$ $I_{B1} = 0.25A$ $V_{BE(off)} = -$		1		μs
tf	Fall Time	BI - 0.207 BE(off) = -	54	0.5		μs

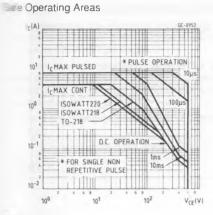
INDUCTIVE LOAD

Symbol	Parameter	Test Conditions		Min.	Тур	Max.	Unit
ts	Storage Time	l _C = 1.25A	h _{FE} = 5		1.2	2.5	μs
tr	Fall Time	V _{CL} = 450V L = 300µH	$V_{BE(off)} = -5V$ $R_{B(off)} = 2\Omega$		0.1	0.2	μs
ts	Storage Time	$I_{C} = 1.25A$ $V_{CL} = 450V$ $L = 300\mu H$ $T_{c} = 100^{\circ}C$	$h_{FE} = 5$ $V_{BE(off)} = -5V$			3.7	μs
tr	Fall Time		$V_{BE(off)} = -5V$ $R_{B(off)} = 2\Omega$			0.3	μs

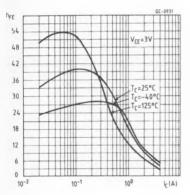
Pulsed : Pulse duration = 300µs, duty cycle = 1.5%



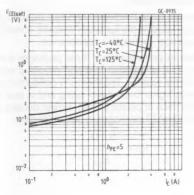
SGSIF325-SGSF425-SGSIF425



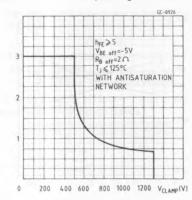




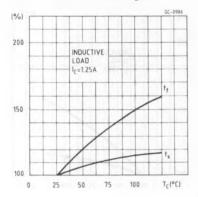
ector-emitter Saturation Voltage



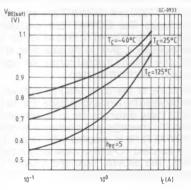
Reverse Biased Safe Operating Area



Collector-emitter Saturation Voltage

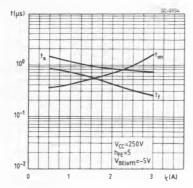


Base-emitter Saturation Voltage

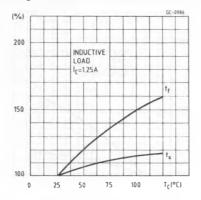




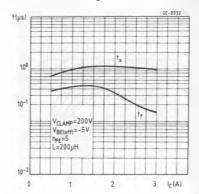
Resistive Load Switching Times



Switching Times Percentance Variation



Inductive Load Switching Times



ISOWATT PACKAGES CHARACTERISTICS AND APPLICATION

The ISOWATT220 and ISOWATT218 are fully isolated packages. The ISOWATT220 is isolated to 2000V dc and the ISOWATT218 to 4000V dc. Their thermal impedance, given in the datasheet, is optimized to give efficient thermal conduction together with excellent electrical isolation.

The structure of the case ensures optimum distances between the pins and heatsink. For the ISO-WATT218 these distances are in agreement with VDE and UL creepage and clearance standards. The ISOWATT218 is supplied with longer leads than the standard TO-218 to allow easy mounting on PCB's. The ISOWATT220 and ISOWATT218 packages eliminate the need for external isolation so reducing fixing hardware. Accurate moulding techniques used in manufacture assures consistent heat spreader-to-heatsink capacitance.

The thermal performance of these packages is better than that of the standard part mounted with a 0.1mm mica washer. The thermally conductive plastic has a higher breakdown rating and is less fragile than mica or plastic sheets. Power derating for these ISOWATT packages is determined by :

$$P_D = \frac{T_j - T_c}{R_{th}}$$



THERMAL IMPEDANCE OF ISOWATT PACKAGES

• 1 illustrates the elements contributing to the e-mal resistance of a transistor heatsink assemusing ISOWATT packages.

The total thermal resistance $R_{th(tot)}$ is the sum of each of these elements. The transient thermal impedance, Z_{th} for different pulse durations can be estimated as follows :

- For a short duration power pulse of less than 1ms :

 $Z_{th} < R_{thJ-C}$

^c gure 1.

2 - For an intermediate power pulse of 5ms to 50ms seconds :

$$Z_{th} = R_{thJ-C}$$

3 - For long power pulses of the order of 500ms se conds or greater :

Zth = RthJ-C + RthC-HS + RthHS-amb

It is often possible to discern these areas on transient thermal impedance curves.



RthJ-C RthC-HS RthHS-amb